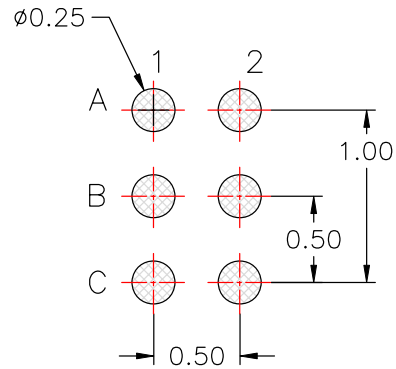
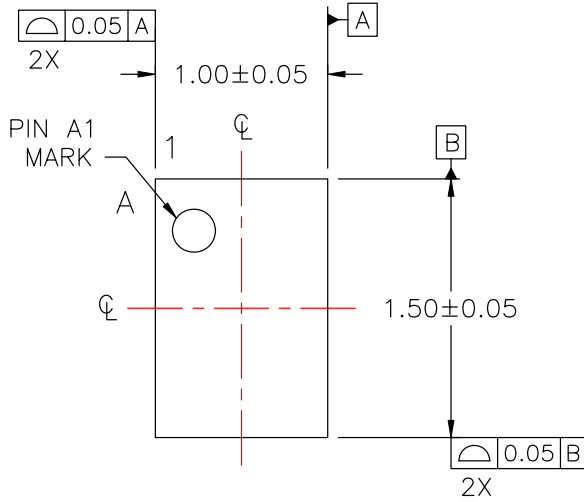


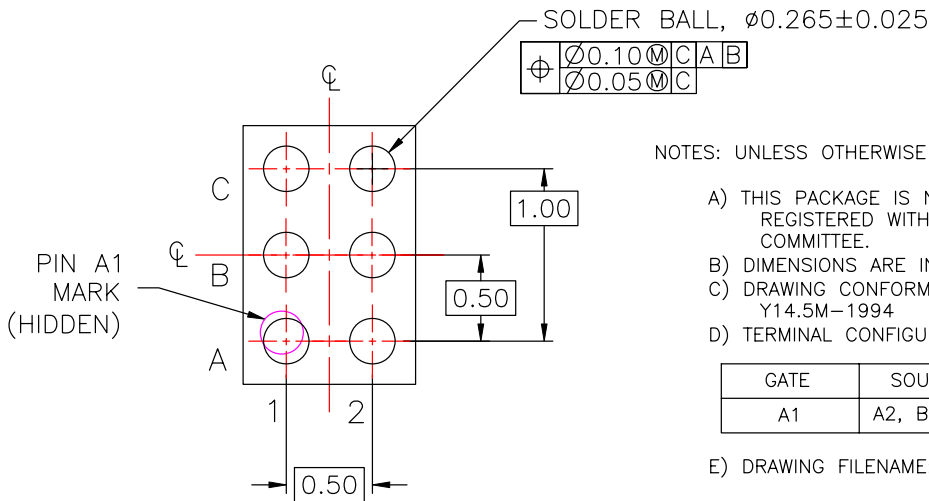
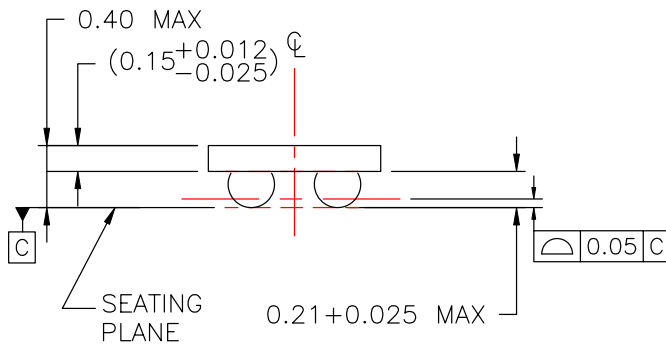
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REVISIONS			
LTR	DESCRIPTION	DATE	NAME/SITE
A	RELEASE TO DOCUMENT CONTROL	13FEB08	JJM/FSCP
2	CHG BUMP HT FR 0.21+0.025 MAX; CHG BALL DIA FR 0.27±0.025 TO 0.265±0.025	09JUL08	JJM/FSCP

**APPROVED**  
August 23, 2008



LAND PATTERN RECOMMENDATION



NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE IS NOT PRESENTLY REGISTERED WITH ANY STANDARDS COMMITTEE.
- B) DIMENSIONS ARE IN MILLIMETERS.
- C) DRAWING CONFORMS TO ASME Y14.5M-1994
- D) TERMINAL CONFIGURATION TABLE:

GATE	SOURCE	DRAIN
A1	A2, B1, B2	C1, C2

E) DRAWING FILENAME: MKT-UC006AEREV2

APPROVALS		DATE			
DRAWN: J.U. COMPARATIVO JR. CHECKED: J.V.J. MANCELITA APPROVED: M.R. GESTOLE G.S. BAJE		09JUL2008			<b>6BALL, WLCSP</b> <b>1.0X1.5X0.4MM, THIN</b>
PROJECTION			SCALE 1:1	SIZE DRAWING NUMBER MKT-UC006AE	
FORMERLY: N/A			SHEET : 1 OF 1		